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## On the Carrier Concentration of Nanocrystalline Si:H Films Made by Inductively Coupled Plasma with Low-Inductance Antenna

H.H. Yang<sup>1</sup> and Jyh-Shiarn Cherng<sup>1</sup>

<sup>1</sup>*Ming Chi University of Technology, Taiwan*

Hydrogenated nanocrystalline silicon (nc-Si:H) film is attractive for photovoltaic applications, as compared to its amorphous counterpart (a-Si:H), due to its spectral response at longer wavelengths, higher doping efficiency, higher mobility, and higher stability against light soaking. In order to manufacture such solar panels at a high enough rate using a plasma-enhanced chemical vapor deposition (PECVD) process, a higher plasma density and a larger yet uniform plasma zone are thus advantageous. Many methods have been proposed to generate such high-density plasmas, and in this study, an inductively coupled plasma (ICP) system using arrays of internal low inductance antennas (LIA) is employed to produce large-area, highly crystallized nc-Si:H films. P-type nc-Si:H thin films are prepared on a glass substrate by such a system with SiH<sub>4</sub>, H<sub>2</sub> and B<sub>2</sub>H<sub>6</sub> as the precursor gases. Both C<sub>H</sub> and R ratio decrease with increasing substrate temperature. The XRR density, GIXRD grain size, and electrical conductivity all consistently increase with substrate temperature. The X<sub>C</sub> increase with substrate temperature until 300°, and then decrease with increasing substrate temperature. The boron concentration is measured by SIMS, and appears unaffected by substrate temperature at around 10<sup>20</sup> atoms/cm<sup>3</sup>, but the carrier concentration increase with substrate temperature from 10<sup>18</sup> to 10<sup>20</sup> cm<sup>-3</sup>. The reason is explained by the breakdown of B-H complex.